Advance Information

Surface Mount Schottky Power Rectifier

SMB Power Surface Mount Package

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Compact Package with J–Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over–Voltage Protection
- Low Forward Voltage Drop
- Mechanical Characteristics:
- Case: Molded Epoxy
- Epoxy Meets UL94, VO at 1/8"
- Weight: 95 mg (approximately)
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Available in 12 mm Tape, 2500 Units per 13" Reel, Add "T3" Suffix to Part Number
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Marking: BGJ

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	WM	
Average Rectified Forward Current (At Rated V _R , T _C = 100°C)	lo	1.5	Amps
Peak Repetitive Forward Current (At Rated V _R , Square Wave, 100 kHz, T _C = 105°C)	IFRM	3.0	Amps
Non–Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	IFSM	40	Amps
Storage / Operating Case Temperature	Tstg, T _C	– 55 to +150	°C
Operating Junction Temperature	Tj	- 55 to +125	°C
Voltage Rate of Change (Rated V _R , $T_J = 25^{\circ}C$)	dv/dt	10,000	V/μs
HERMAL CHARACTERISTICS	•		•
Thermal Resistance — Junction-to-Lead (2) Thermal Resistance — Junction-to-Ambient (2)	R _{θJL} R _{θJA}	24 80	°C/W

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage ⁽¹⁾	VF	TJ = 25°C	Тј = 125°С	Volts
(I _F = 1.5 A) see Figure 2 (I _F = 3.0 A)		0.46 0.54	0.39 0.54	
Maximum Instantaneous Reverse Current	IR	Tj = 25°C	TJ = 100°C	mA
$(V_{R} = 40 V)$ see Figure 4 $(V_{R} = 20 V)$		0.8 0.1	5.7 1.6	

This document contains information on a new product. Specifications and information herein are subject to change without notice.

(1) Pulse Test: Pulse Width \leq 250 µs, Duty Cycle \leq 2.0%.

(2) Mounted with minimum recommended pad size, PC Board FR4.



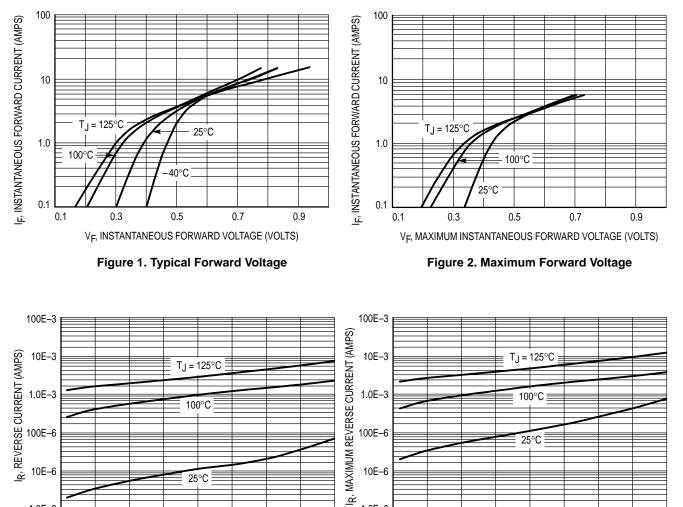
SCHOTTKY BARRIER RECTIFIER 1.5 AMPERES 40 VOLTS

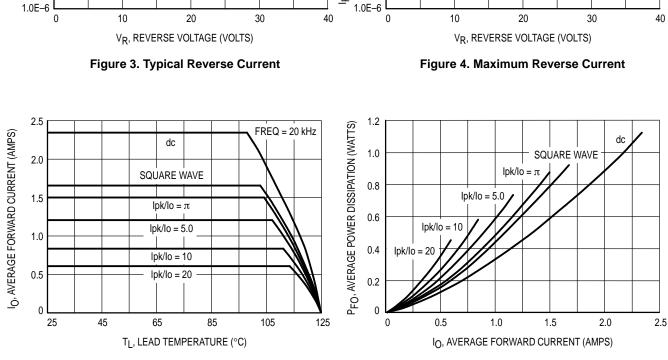




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10E-6





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Figure 5. Current Derating

25°C

Figure 6. Forward Power Dissipation

MBRS1540T3

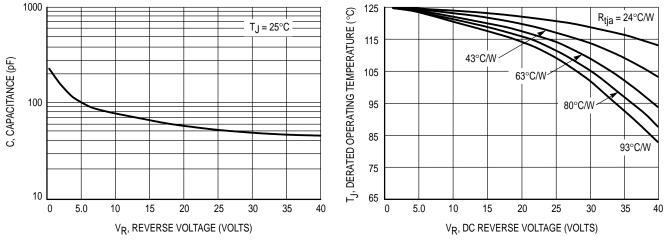


Figure 7. Capacitance

Figure 8. Typical Operating Temperature Derating*

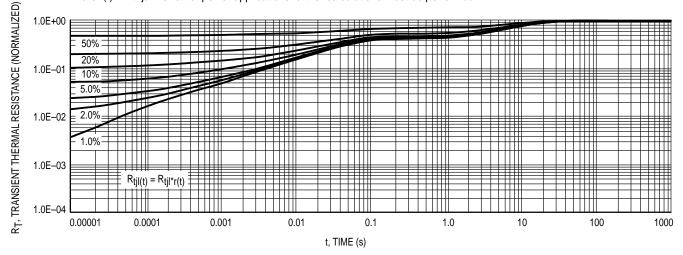
* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of T_J therefore must include forward and reverse power effects. The allowable operating T_J may be calculated from the equation: $T_J = T_{Jmax} - r(t)(Pf + Pr)$ where

r(t) = thermal impedance under given conditions,

Pf = forward power dissipation, and

Pr = reverse power dissipation

This graph displays the derated allowable T_J due to reverse bias under DC conditions only and is calculated as $T_J = T_{Jmax} - r(t)Pr$, where r(t) = Rthja. For other power applications further calculations must be performed.





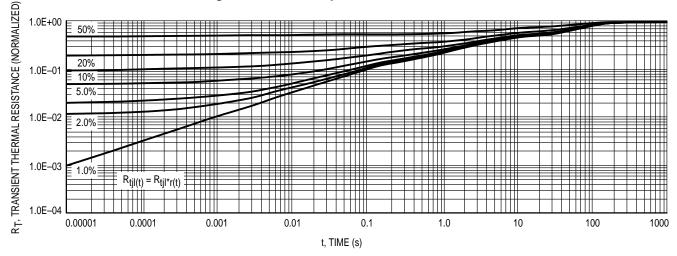
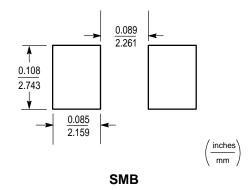
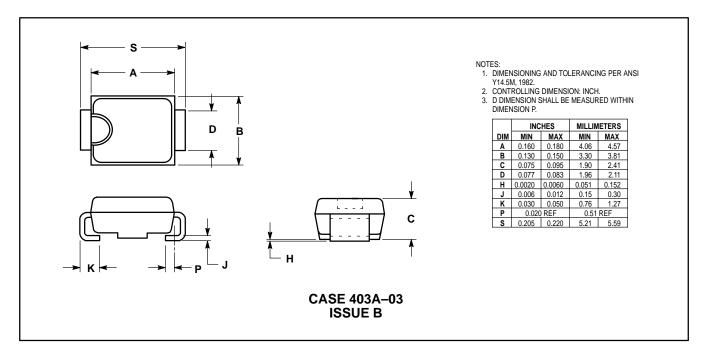


Figure 10. Thermal Response — Junction to Ambient



PACKAGE DIMENSIONS



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